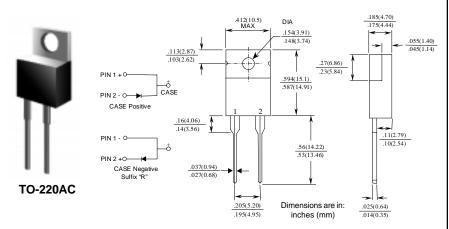


# Discrete POWER & Signal Technologies

# FES16AT - FES16JT

#### **Features**

- Low forward voltage drop.
- High surge current capacity.
- High current capability.
- High reliability.



# 16 Ampere Glass Passivated Super Fast Rectifiers

**Absolute Maximum Ratings\*** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
Io	Average Rectified Current	16	Α	
	.375 " lead length @ T <sub>A</sub> = 100°C			
i <sub>f(surge)</sub>	Peak Forward Surge Current			
(4-1-9-)	8.3 ms single half-sine-wave	250	Α	
	Superimposed on rated load (JEDEC method)			
P <sub>D</sub>	Total Device Dissipation	7.81	W	
	Derate above 25°C	62	mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	16	°C/W	
$R_{\theta JL}$	Thermal Resistance, Junction to Lead	1.2	°C/W	
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C	
TJ	Operating Junction Temperature	-65 to +150	°C	

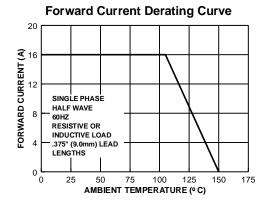
<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

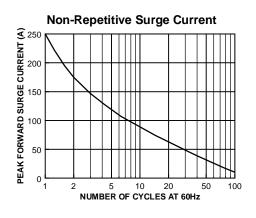
### **Electrical Characteristics**

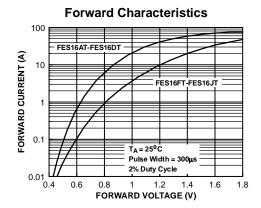
т.	= 25°C	unless	otherv	vise i	noted

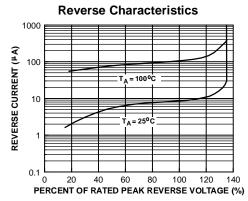
Parameter		Device							Units
	16AT	16BT	16CT	16DT	16FT	16GT	16HT	16JT	
Peak Repetitive Reverse Voltage	50	100	150	200	300	400	500	600	V
Maximum RMS Voltage	35	70	105	140	210	280	350	420	V
DC Blocking Voltage (Rated V <sub>R</sub> )	50	100	150	200	300	400	500	600	V
Maximum Reverse Current									
@ rated $V_R$ $T_A = 25^{\circ}C$		10						μΑ	
$T_A = 100^{\circ}C$				5	00				μΑ
Maximum Reverse Recovery Time		35 50							
$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{RR} = 0.25 \text{ A}$		35 50					nS		
Maximum Forward Voltage @ 16.0A		0.975 1.3				1	.5	V	
Typical Junction Capacitance $V_R = 4.0$ . $f = 1.0$ MHz		170 145						pF	

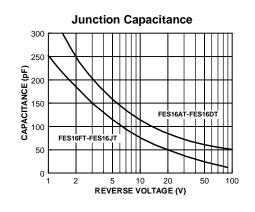
### **Typical Characteristics**

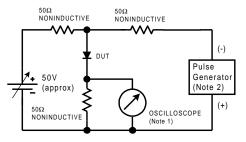


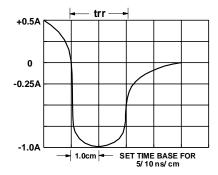












**Reverse Recovery Time Characterstic and Test Circuit Diagram** 

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E<sup>2</sup>CMOS<sup>™</sup> PowerTrench<sup>™</sup>

FACT<sup>TM</sup> QS<sup>TM</sup>

FACT Quiet Series  $^{\text{TM}}$  Quiet Series  $^{\text{TM}}$  SuperSOT  $^{\text{TM}}$ -3 SuperSOT  $^{\text{TM}}$ -6 GTO  $^{\text{TM}}$  SuperSOT  $^{\text{TM}}$ -8 HiSeC  $^{\text{TM}}$  TinyLogic  $^{\text{TM}}$ 

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